

# 101512C

## FB357.5-1.25 357.5 MHz Bandpass Filter 1.25 MHz Bandwidth

## **Specifications**

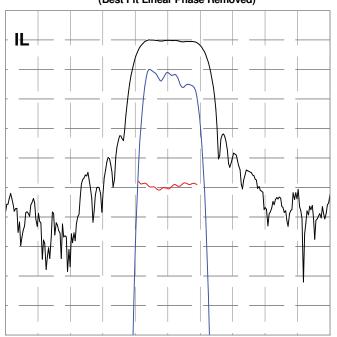
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	F <sub>0</sub>		357.5		MHz
Bandwidth	В		1.25		MHz
-3 dB Bandwidth	В3	1.2	1.2		MHz
-40 dB Bandwidth	B <sub>40</sub>		2	2.3	MHz
Delay	T <sub>0</sub>	2.6	2.62	2.64	µsec
Insertion Loss	IL		21.3	25	dB
Amplitude Ripple			1.4	2.5	dB <sub>P-P</sub>
Phase Ripple			2.3	4	deg <sub>P-P</sub>
Rejection		42	45		dB
Spurious for $ t - T_0  > .9T_0$			-37	-36	dB
Substrate Material	36YX-Q				

#### **Notes**

- 1. Center Frequency (F<sub>0</sub>) and Bandwidth (B) are defined, not measured.
- 2. Insertion Loss is the minimum loss for  $|f F_0| < .5B$
- 3. Ripple spec applies to the  $|f F_0| < .4B$ , and is doubled for  $.4B < |f F_0| < .5B$
- 4. Rejection spec applies to  $(B_{40} \text{ Spec} B/2) < |f F_0| < F_0/2$
- 5. Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts  $dF_0 = -x * F_0$ ,  $dT_0 = x * T_0$ , where  $x = 3E-8 * (temperature 22 °C)^2$

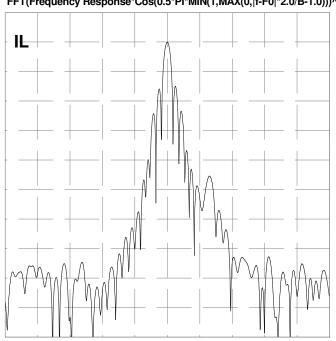
#### **Typical Performance**

# Frequency Response (Best Fit Linear Phase Removed)



10 dB/div, 1 dB/div, 10 deg/div, 0.625 MHz/div

# Impulse Response FFT(Frequency Response\*Cos(0.5\*PI\*MIN(1,MAX(0,|f-F0|\*2.0/B-1.0)))^2)



10 dB/div, 4.096 us/div



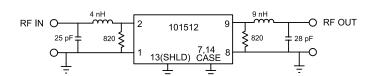
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### **Package Outline**

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## Matching





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